PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Takashi Katou	01/31/2013
Takehiko Tanaka	02/07/2013
Hiromichi Kawakita	01/31/2013
Yasuhiro Yoshida	01/31/2013
Tatsuya Kakuta	01/31/2013

RECEIVING PARTY DATA

Name:	AUTONETWORKS TECHNOLOGIES, LTD.
Street Address:	1-14, Nishisuehiro-cho
City:	Yokkaichi-City, Mie
State/Country:	JAPAN
Postal Code:	510-8503

Name:	Sumitomo Wiring Systems, Ltd.
Street Address:	1-14, Nishisuehiro-cho
City:	Yokkaichi-City, Mie
State/Country:	JAPAN
Postal Code:	510-8503

Name:	SUMITOMO ELECTRIC INDUSTRIES, LTD.
Street Address:	5-33, Kitahama 4-chome, Chuo-ku
City:	Osaka-shi, Osaka
State/Country:	JAPAN
Postal Code:	541-0041

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13816782

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CORRESPONDENCE DATA

Fax Number: 2127252452

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 2127252450

Email: email@hpiplaw.com

Correspondent Name: HESPOS & PORCO LLP

Address Line 1: 110 West 40th Street

Address Line 2: Suite 2501

Address Line 4: NEW YORK, NEW YORK 10018

ATTORNEY DOCKET NUMBER:	FPCT12-294US
NAME OF SUBMITTER:	Gerald E. Hespos

Total Attachments: 1

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Atty. Ref.: FPCT12-294US

ASSIGNMENT

In consideration of the sum of One Dollar ($1.00), and of other good and valuable consideration paid to the undersigned by the Assignees, 1) AUTONETWORKS TECHNOLOGIES, LTD., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503 Japan, 2) Sumitomo Wiring Systems, Ltd., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503 Japan and 3) SUMITOMO ELECTRIC INDUSTRIES, LTD., a corporation organized under the laws of Japan, located at 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka, 541-0041 Japan, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers and sets over unto the said assignee the entire right, title and interest in and to the invention or improvement entitled "METHOD OF MANUFACTURING WATERPROOF INTERMEDIATE SPLICED PORTION OF WIRES AND WATERPROOF INTERMEDIATE UNIT OF WIRES", said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee Is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries at its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefor to said Assignee, its successors, assigns or other legal representatives, and, upon the request and at the expense of said assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of any Letters Patent to be granted therefor, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein, without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

And The Commissioner Of Patents Is Hereby Authorized And Requested to issue any and all Letters Patent of the United States for said invention, to said assignee.

January 31. 2013 Date	Takashi Katou Takashi Katou
February 7, 2013 Date	Takehiko Tanaka Takehiko Tanaka
January 31, 2013 Date	Hiromichi Kawakita Hiromichi Kawakita
January 31, 2013 Date	Yasuhiro Yoshida Yasuhiro Yoshida
January 31, 2013 Date	Tatsuya Kakuta Tatsuya Kakuta